RoHS

COMPLIANT

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**PRODUCT SUMMARY** 

 $R_{DS(on)} \mbox{ max. } (\Omega) \mbox{ at } V_{GS} = 10 \mbox{ V} \\ R_{DS(on)} \mbox{ max. } (\Omega) \mbox{ at } V_{GS} = 4.5 \mbox{ V}$ 

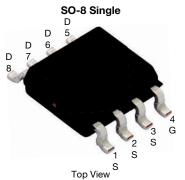
V<sub>DS</sub> (V)

I<sub>D</sub> (A) <sup>a</sup>

Q<sub>g</sub> typ. (nC)

Configuration

Vishay Siliconix



# FEATURES TrenchFET<sup>®</sup> power MOSFET

40

0.0045

0.0060

29

27.2

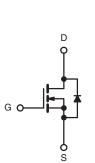
Single

N-Channel 40 V (D-S) MOSFET

- 100 % R<sub>g</sub> and UIS tested
- Material categorization: for definitions of compliance please see www.vishav.com/doc?99912

### **APPLICATIONS**

• DC/DC conversion



N-Channel MOSFET

ORDERING INFORMATION				
Package	SO-8			
Lead (Pb)-free and halogen-free	Si4122DY-T1-GE3			

ABSOLUTE MAXIMUM RATING	<b>iS</b> (T <sub>A</sub> = 25 °C, ι	inless otherv	vise noted)		
PARAMETER		SYMBOL	LIMIT	UNIT	
Drain-source voltage		V <sub>DS</sub>	40	V	
Gate-source voltage		V <sub>GS</sub>	± 25		
Continuous drain current (T <sub>J</sub> = 150 °C)	T <sub>C</sub> = 25 °C		27.2		
	T <sub>C</sub> = 70 °C	1.[	20.1		
	T <sub>A</sub> = 25 °C		19.2 <sup>b, c</sup>		
	T <sub>A</sub> = 70 °C	1	15.3 <sup>b, c</sup>		
Pulsed drain current		I <sub>DM</sub>	70	A	
Continuous source-drain diode current	T <sub>C</sub> = 25 °C	- I <sub>S</sub>	5.4		
	T <sub>A</sub> = 25 °C		2.7 <sup>b, c</sup>		
Single pulse avalanche current		I <sub>AS</sub>	40		
Avalanche energy	L = 0.1 mH	E <sub>AS</sub>	80	mJ	
Maximum power dissipation	T <sub>C</sub> = 25 °C		6		
	T <sub>C</sub> = 70 °C		3.3	14/	
	T <sub>A</sub> = 25 °C	P <sub>D</sub>	3 b, c	W	
	T <sub>A</sub> = 70 °C	1	1.9 <sup>b, c</sup>		
Operating junction and storage temperature range		T <sub>J</sub> , T <sub>stg</sub>	-55 to +150	°C	

THERMAL RESISTANCE RATINGS						
PARAMETER		SYMBOL	TYPICAL	MAXIMUM	UNIT	
Maximum junction-to-ambient b, d	t ≤ 10 s	R <sub>thJA</sub>	33	42	°C/W	
Maximum junction-to-foot (drain)	Steady state	R <sub>thJF</sub>	16	21	0/10	

Notes

a. Based on  $T_C = 25 \ ^{\circ}C$ 

b. Surface mounted on 1" x 1" FR4 board

c. t = 10 s

d. Maximum under steady state conditions is 85  $^\circ\text{C/W}$ 

S-81220-Rev. A, 02-Jun-08

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# Si4122DY

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PARAMETER	SYMBOL	TEST CONDITIONS	MIN.	TYP.	MAX.	UNIT	
Static							
Drain-source breakdown voltage	V <sub>DS</sub>	$V_{GS} = 0 V, I_D = 250 \mu A$	40	-	-	V	
V <sub>DS</sub> temperature coefficient	$\Delta V_{DS}/T_{J}$	L 050 A	-	43	-	mV/°C	
V <sub>GS(th)</sub> temperature coefficient	$\Delta V_{GS(th)}/T_J$	I <sub>D</sub> = 250 μA	-	-6	-		
Gate-source threshold voltage	V <sub>GS(th)</sub>	$V_{DS} = V_{GS}$ , $I_D = 250 \ \mu A$	1.2	-	2.5	V	
Gate-source leakage	I <sub>GSS</sub>	$V_{DS} = 0 V, V_{GS} = \pm 25 V$	-	-	± 100	nA	
		$V_{DS} = 40 \text{ V}, \text{ V}_{GS} = 0 \text{ V}$	-	-	1	μΑ	
Zero gate voltage drain current	I <sub>DSS</sub>	V <sub>DS</sub> = 40 V, V <sub>GS</sub> = 0 V, T <sub>J</sub> = 55 °C	-	-	10		
On-state drain current <sup>a</sup>	I <sub>D(on)</sub>	$V_{DS} \ge 5 \text{ V}, \text{ V}_{GS} = 10 \text{ V}$	30	-	-	А	
	D	$V_{GS} = 10 \text{ V}, \text{ I}_{D} = 15 \text{ A}$	-	0.0036	0.0045	Ω	
Drain-source on-state resistance <sup>a</sup>	R <sub>DS(on)</sub>	$V_{GS} = 4.5 \text{ V}, I_D = 10 \text{ A}$	-	0.0048	0.0060		
Forward transconductance a	9 <sub>fs</sub>	V <sub>DS</sub> = 15 V, I <sub>D</sub> = 15 A	-	65	-	S	
Dynamic <sup>b</sup>							
Input capacitance	C <sub>iss</sub>		-	4200	-	pF	
Output capacitance	C <sub>oss</sub>	V <sub>DS</sub> = 20 V, V <sub>GS</sub> = 0 V, f = 1 MHz	-	475	-		
Reverse transfer capacitance	C <sub>rss</sub>		-	225	-		
Total gate charge	Qg	$V_{DS} = 20 \text{ V}, V_{GS} = 10 \text{ V}, I_D = 10 \text{ A}$	-	62	95	nC	
			-	29	44		
Gate-source charge	Q <sub>gs</sub>	$V_{DS} = 20 \text{ V}, \text{ V}_{GS} = 4.5 \text{ V}, \text{ I}_{D} = 10 \text{ A}$	-	12	-		
Gate-drain charge	Q <sub>qd</sub>		-	9	-		
Gate resistance	R <sub>q</sub>	f = 1 MHz	0.2	1	2	Ω	
Turn-on delay time	t <sub>d(on)</sub>		-	42	70	•	
Rise time	t <sub>r</sub>	$V_{DD} = 20 V, R_1 = 2 \Omega$	-	34	60		
Turn-off delay time	t <sub>d(off)</sub>	$I_D \cong 10 \text{ Å}, V_{GEN} = 4.5 \text{ V}, \text{ R}_{g} = 1 \Omega$	-	45	75		
Fall time	t <sub>f</sub>		-	28	45		
Turn-on delay time	t <sub>d(on)</sub>		-	14	25	ns	
Rise time	t <sub>r</sub>	$V_{DD} = 20 \text{ V}, \text{ R}_{L} = 2 \Omega$	-	10	20		
Turn-off delay time	t <sub>d(off)</sub>	$I_D \cong 10 \text{ A}, V_{GEN} = 10 \text{ V}, R_g = 1 \Omega$	-	35	60		
Fall time	t <sub>f</sub>		-	9	18		
Drain-Source Body Diode Characterist	ics					1	
Continuous source-drain diode current	I <sub>S</sub>	T <sub>C</sub> = 25 °C	-	-	5.4		
Pulse diode forward current <sup>a</sup>	I <sub>SM</sub>		-	-	70	A	
Body diode voltage	V <sub>SD</sub>	I <sub>S</sub> = 3 A	-	0.72	1.1	V	
Body diode reverse recovery time	t <sub>rr</sub>	-	-	31	50	ns	
Body diode reverse recovery charge	Q <sub>rr</sub>	I <sub>F</sub> = 5 A, di/dt = 100 A/μs,	_	31	50	nC	
Reverse recovery fall time	t <sub>a</sub>	$T_{\rm J} = 25 ^{\circ}{\rm C}$	_	18	-	-	
						ns	

Notes

a. Pulse test; pulse width  $\leq$  300 µs, duty cycle  $\leq$  2 %

b. Guaranteed by design, not subject to production testing

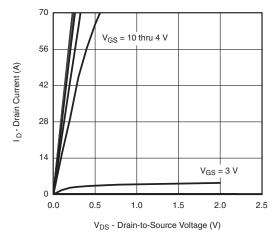
Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

2

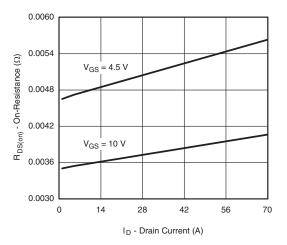


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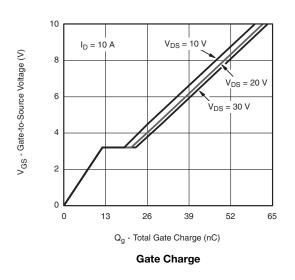
### TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)

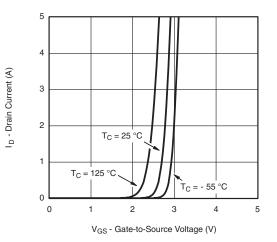


**Output Characteristics** 

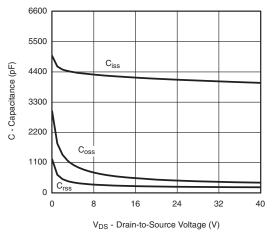


**On-Resistance vs. Drain Current and Gate Voltage** 

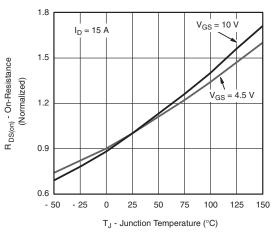




Transfer Characteristics



Capacitance



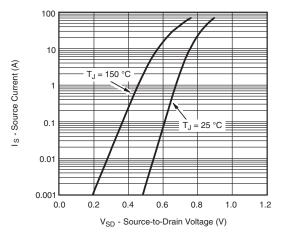
**On-Resistance vs. Junction Temperature** 

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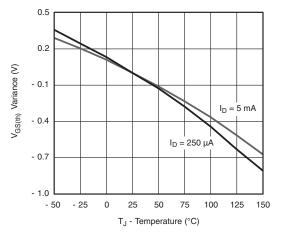


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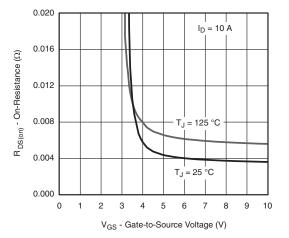
## TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)



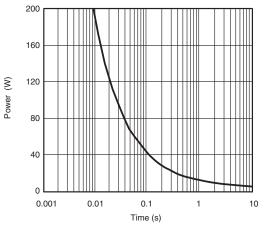
Source-Drain Diode Forward Voltage



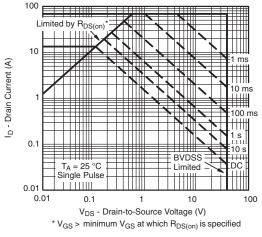




**On-Resistance vs. Gate-to-Source Voltage** 







Safe Operating Area, Junction-to-Ambient

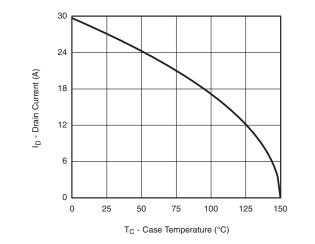
4

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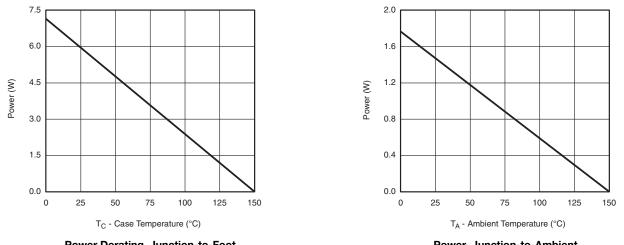


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### TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)



Current Derating a



Power Derating, Junction-to-Foot

Power, Junction-to-Ambient

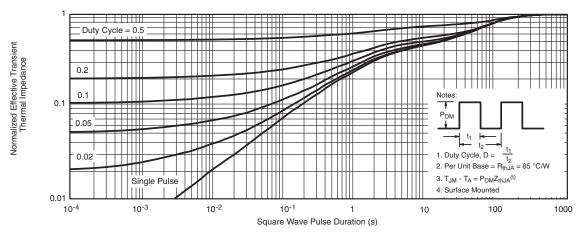
#### Note

a. The power dissipation P<sub>D</sub> is based on T<sub>J</sub> max. = 150 °C, using junction-to-case thermal resistance, and is more useful in settling the upper dissipation limit for cases where additional heatsinking is used. It is used to determine the current rating, when this rating falls below the package limit

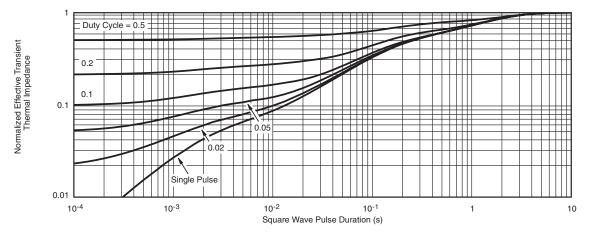


**Vishay Siliconix** 

### TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)



Normalized Thermal Transient Impedance, Junction-to-Ambient



Normalized Thermal Transient Impedance, Junction-to-Foot

Vishay Siliconix maintains worldwide manufacturing capability. Products may be manufactured at one of several qualified locations. Reliability data for Silicon Technology and Package Reliability represent a composite of all qualified locations. For related documents such as package / tape drawings, part marking, and reliability data, see www.vishay.com/ppg?68665.

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# Package Information

Vishay Siliconix

# SOIC (NARROW): 8-LEAD JEDEC Part Number: MS-012





	MILLIM	IETERS	INC	HES	
DIM	Min	Мах	Min	Max	
A	1.35	1.75	0.053	0.069	
A <sub>1</sub>	0.10	0.20	0.004	0.008	
В	0.35	0.51	0.014	0.020	
С	0.19	0.25	0.0075	0.010	
D	4.80	5.00	0.189	0.196	
E	3.80	4.00	0.150	0.157	
е	1.27	BSC	0.050 BSC		
н	5.80	6.20	0.228	0.244	
h	0.25	0.50	0.010	0.020	
L	0.50	0.93	0.020	0.037	
q	0°	8°	0°	8°	
S	0.44	0.64	0.018	0.026	
ECN: C-06527-Rev. I, 11-Sep-06 DWG: 5498					

## **Application Note 826**

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**RECOMMENDED MINIMUM PADS FOR SO-8** 



Recommended Minimum Pads Dimensions in Inches/(mm)

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